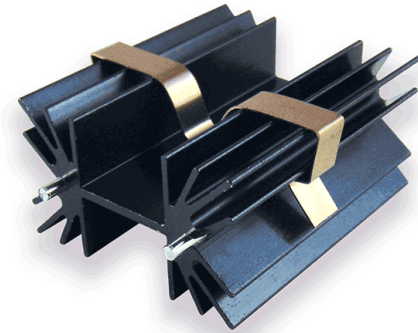


## Product Data Sheet Type: PR33/50,8/MC

Group: HEATSINKS Board Level

For single mounting

Width : 42 mm  
 Height : 25 mm  
 Length : 50.8 mm  
 Minimum thermal resistance : 4,2 K/W  
 For device : TO 220|TO 218|TOP 3  
 Device mounted by : Clip Mounting  
 Heatsink mounted by : Solder  
 Surface : Black Anodised  
 Material : AlMgSi0,5



- Special extruded heatsink for semiconductor case TO220, TO218(TOP3)
- Aluminium, anodised black, solderable
- Standard heights: 25.4, 38.1, 50.8 and 63.5 mm
- Version MC (Mounting clip) for clip mounting of semiconductor.
- Heatsink solderable by tin plated solder pins

